**ON Semiconductor** 

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# Onsemi

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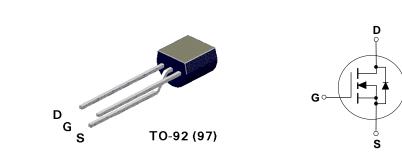
ON Semiconductor® BS270 N-Channel Enhancement Mode Field Effect Transistor

# **General Description**

These N-Channel enhancement mode field effect transistors are produced using ON Semiconductor's proprietary, high cell density, DMOS technology. These products have been designed to minimize on-state resistance while provide rugged, reliable, and fast switching performance. They can be used in most applications requiring up to 500mA DC. These products are particularly suited for low voltage, low current applications such as small servo motor control, power MOSFET gate drivers, and other switching applications.

### Features

- 400mA, 60V.  $R_{DS(ON)} = 2\Omega @ V_{GS} = 10V.$
- High density cell design for low R<sub>DS(ON)</sub>.
- Voltage controlled small signal switch.
- Rugged and reliable.
- High saturation current capability.



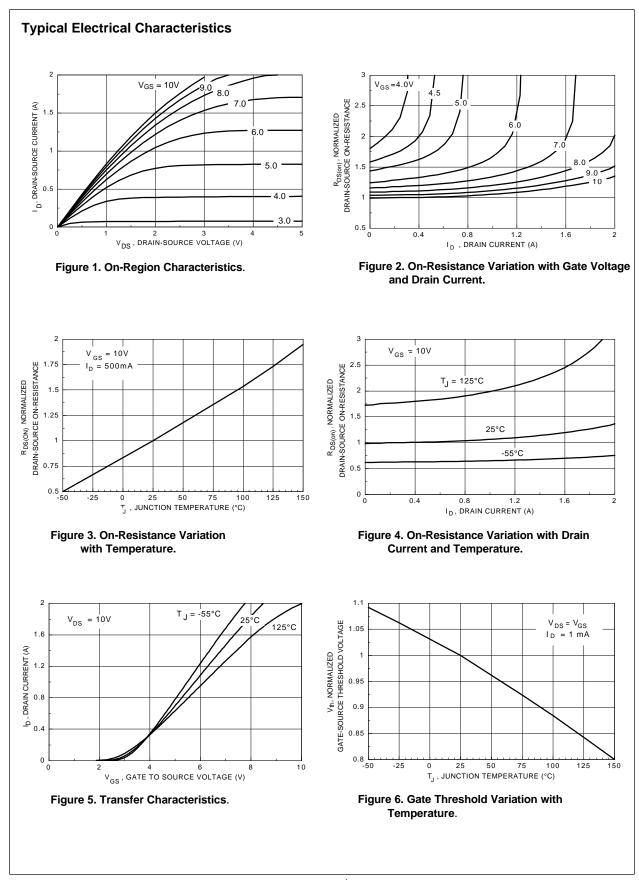
# **Absolute Maximum Ratings** $T_A = 25^{\circ}C$ unless otherwise noted

| Symbol               | Parameter  | BS270      | Units    |
|----------------------|--|------------|----------|
| V <sub>DSS</sub>     | Drain-Source Voltage   | 60         | V        |
| $V_{\text{DGR}}$     | Drain-Gate Voltage ( $R_{gs} \le 1M\Omega$ )                                       | 60         | V        |
| V <sub>GSS</sub>     | Gate-Source Voltage - Continuous   | ±20        | V        |
|                      | - Non Repetitive (tp < 50µs)   | ±40        |          |
| I <sub>D</sub>       | Drain Current - Continuous   | 400        | mA       |
|                      | - Pulsed   | 2000       |          |
| P <sub>D</sub>       | Maximum Power Dissipation  | 625        | mW       |
|                      | Derate Above 25°C  | 5          | mW/°C    |
| T_,,T <sub>stg</sub> | Operating and Storage Temperature Range  | -55 to 150 | °C       |
| TL                   | Maximum Lead Temperature for Soldering<br>Purposes, 1/16" from Case for 10 Seconds | 300        | °C       |
| THERMA               | L CHARACTERISTICS  |            | <u>.</u> |
| R <sub>eja</sub>     | Thermal Resistacne, Junction-to-Ambient  | 200        | °C/W     |

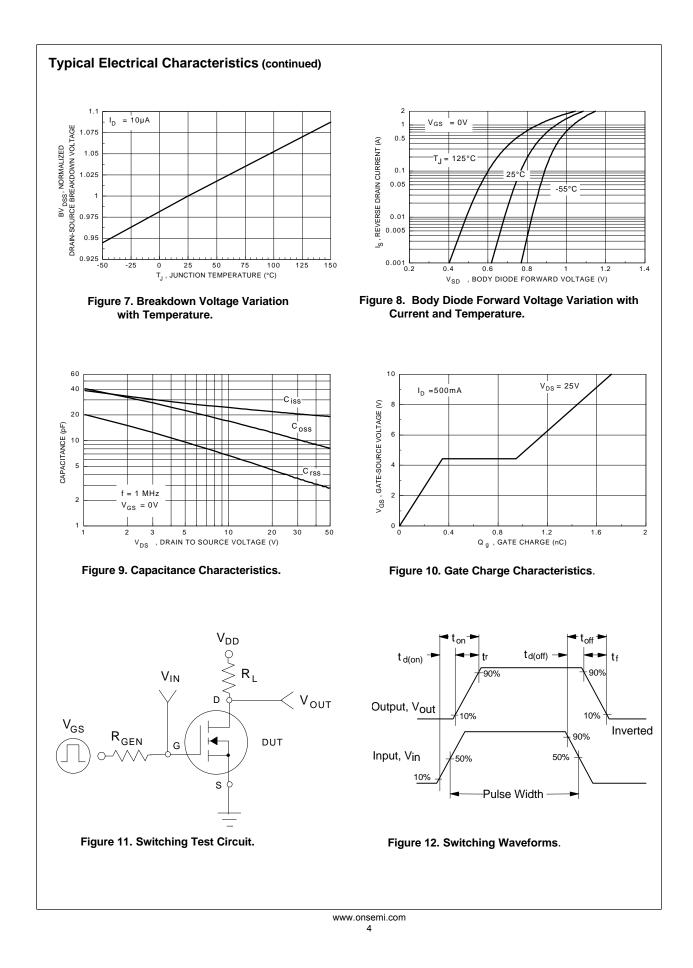
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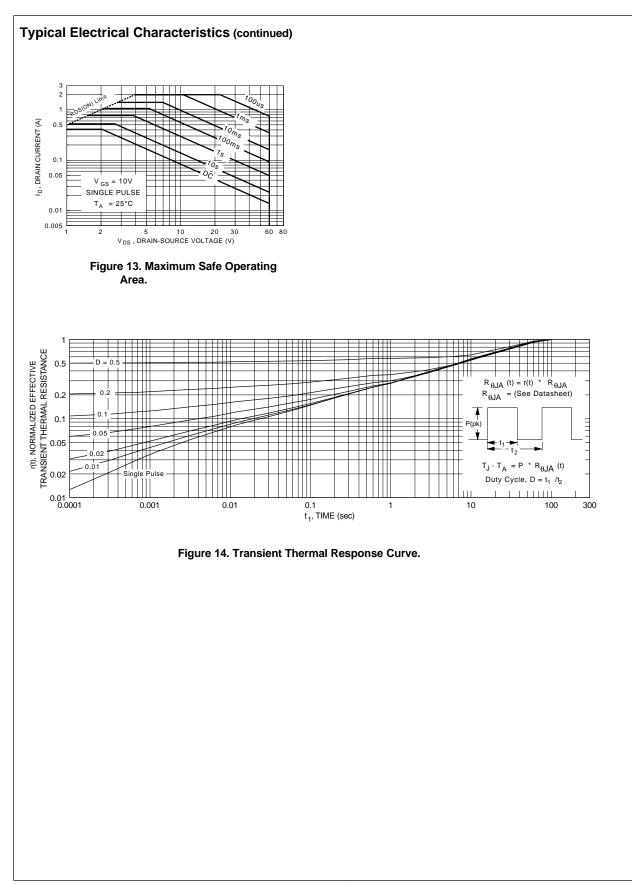
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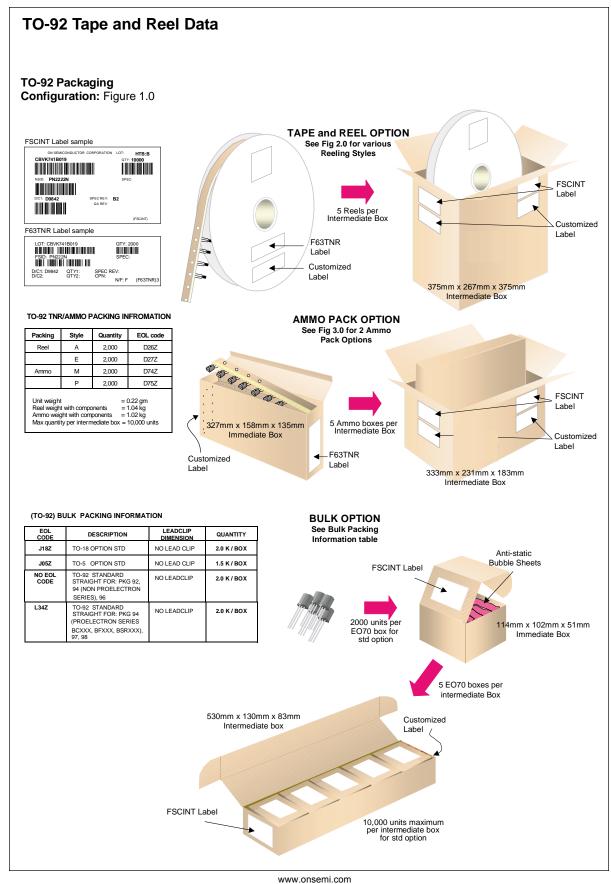
| Symbol              | Parameter   | Conditions   |                        | Min       | Тур  | Max   | Units |
|---------------------|---|--|------------------------|-----------|------|-------|-------|
| OFF CHA             | RACTERISTICS  | ·  |                        |           |      |       |       |
| BV <sub>DSS</sub>   | Drain-Source Breakdown Voltage                        | $V_{gs} = 0 V, I_{p} = 10 \mu A$                                       |                        | 60        |      |       | V     |
| I <sub>DSS</sub>    | Zero Gate Voltage Drain Current                       | $V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$                          |                        |           |      | 1     | μA    |
|                     |   |  | T <sub>J</sub> = 125°C |           |      | 500   | μA    |
| GSSF                | Gate - Body Leakage, Forward                          | $V_{gg} = 20 V, V_{Dg} = 0 V$  | •                      |           |      | 10    | nA    |
| GSSF                | Gate - Body Leakage, Reverse                          | $V_{gg} = -20 \text{ V}, V_{Dg} = 0 \text{ V}$                         |                        |           |      | -10   | nA    |
|                     | ACTERISTICS (Note 1)                                  |  |                        |           |      |       |       |
| V <sub>GS(th)</sub> | Gate Threshold Voltage                                | $V_{ps} = V_{qs}, I_{p} = 250 \ \mu A$                                 |                        | 1         | 2.1  | 2.5   | V     |
| R <sub>DS(ON)</sub> | Static Drain-Source On-Resistance                     | V <sub>gs</sub> = 10 V, I <sub>p</sub> = 500 mA                        |                        |           | 1.2  | 2     | Ω     |
|                     |   |  | T_ = 125°C             |           | 2    | 3.5   |       |
|                     |   | V <sub>gs</sub> = 4.5 V, I <sub>p</sub> = 75 mA                        |                        |           | 1.8  | 3     |       |
| V <sub>DS(ON)</sub> | Drain-Source On-Voltage                               | $V_{GS} = 10 \text{ V}, \text{ I}_{D} = 500 \text{ mA}$                |                        |           | 0.6  | 1 V   |       |
|                     |   | $V_{GS} = 4.5 \text{ V}, I_{D} = 75 \text{ mA}$                        |                        |           | 0.14 | 0.225 |       |
| I <sub>D(ON)</sub>  | On-State Drain Current                                | $V_{gg} = 10 \text{ V}, V_{Dg} \ge 2 \text{ V}_{DS(on)}$               |                        | 2000 2700 |      |       | mA    |
|                     |   | $V_{gg} = 4.5 \text{ V}, V_{Dg} \ge 2 \text{ V}_{DS(on)}$              | 2 V <sub>DS(on)</sub>  |           | 600  |       |       |
| ) <sub>FS</sub>     | Forward Transconductance                              | $V_{\text{DS}} \ge 2 V_{\text{DS(on)}}, I_{\text{D}} = 200 \text{ mA}$ |                        | 100       | 320  |       | mS    |
| DYNAMIC             | CHARACTERISTICS                                       | • • • • •  |                        |           |      | •     |       |
| C <sub>iss</sub>    | Input Capacitance                                     | $V_{DS} = 25 V, V_{GS} = 0 V,$<br>f = 1.0 MHz                          |                        |           | 20   | 50    | pF    |
| C <sub>oss</sub>    | Output Capacitance                                    | f = 1.0 MHz  |                        |           | 11   | 25    | pF    |
| C <sub>rss</sub>    | Reverse Transfer Capacitance                          |  |                        |           | 4    | 5     | pF    |
| SWITCHIN            | G CHARACTERISTICS (Note 1)                            |  |                        |           |      |       |       |
| 'on                 | Turn-On Time  | $V_{DD} = 30 \text{ V}, \ I_{D} = 500 \text{ m A},$                    |                        |           |      | 10    | ns    |
| off                 | Turn-Off Time   | $V_{GS}$ = 10 V, $R_{GEN}$ = 25 $\Omega$                               |                        |           |      | 10    | ns    |
| ORAIN-SO            | URCE DIODE CHARACTERISTICS ANI                        | D MAXIMUM RATINGS  |                        |           | -    | -     |       |
|                     | Maximum Continuous Drain-Source Diode Forward Current |  |                        |           | 400  | mA    |       |
| S                   |   | Maximum Pulsed Drain-Source Diode Forward Current                      |                        |           |      | 2000  | mA    |
| s<br>sm             | Maximum Pulsed Drain-Source Diode F                   | orward Current   |                        |           |      | 2000  | 110.  |



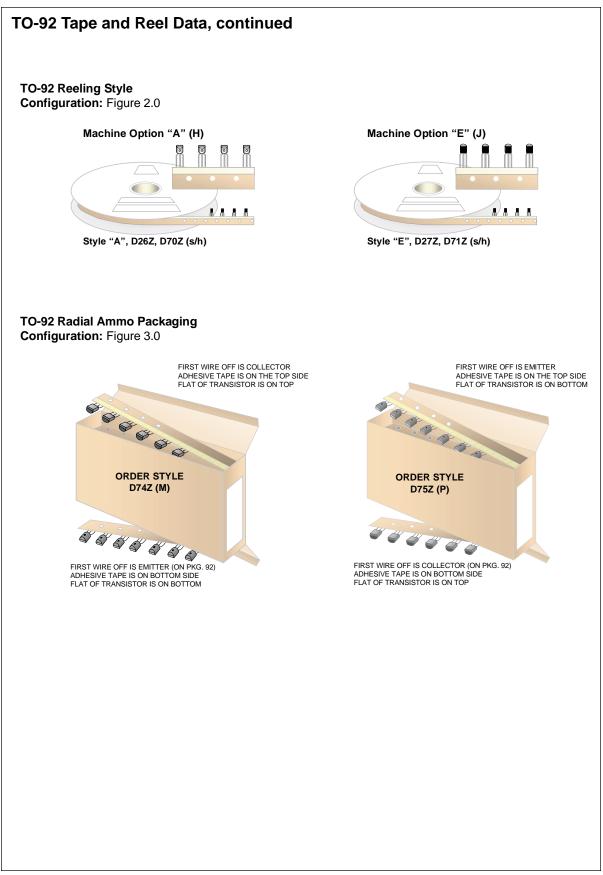
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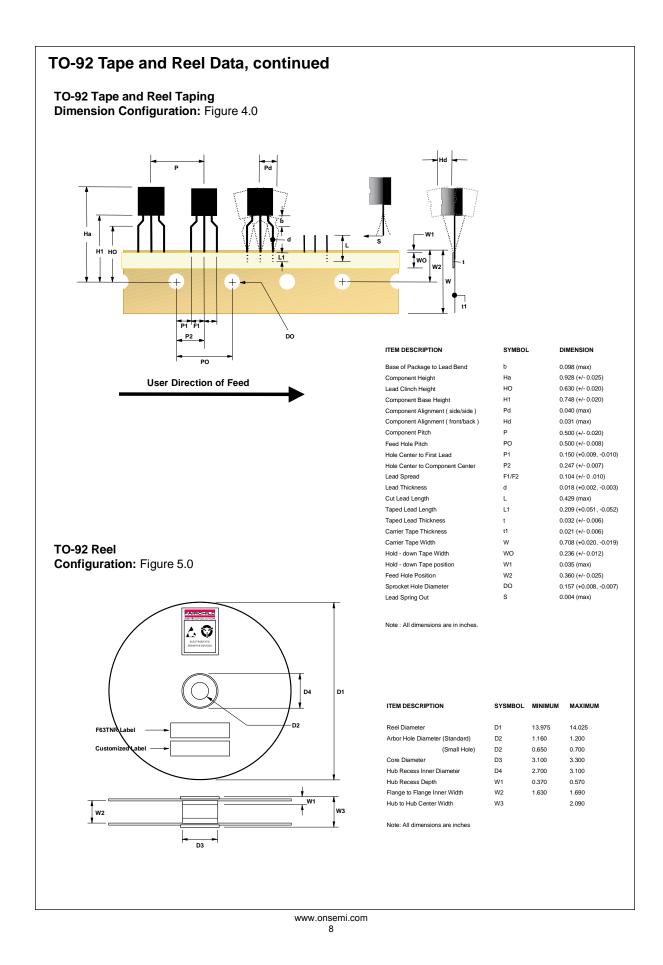


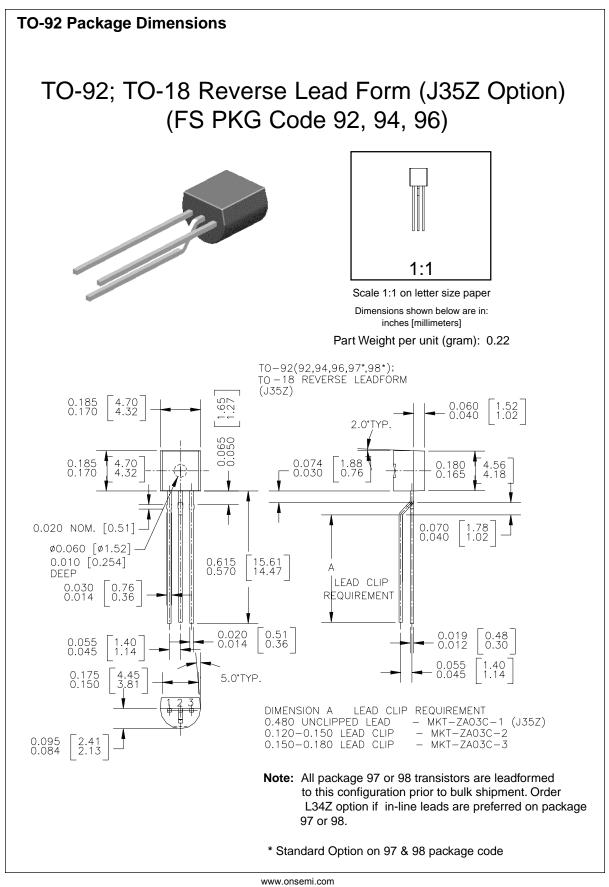




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